

L Number	Hits	Search Text	DB	Time stamp
-	24	(thermoset\$4) same (copper or conductor) same (resin or adhesive) same (pcb or (circuit near board)) same (ptfe or polytetrafluoroethylene or fluoropolymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 14:11
-	48	(thermoset\$4) same (copper or conductor) same (resin or adhesive) same (pcb or (circuit near board)) same (coat or coated or coating) same (multilayer or (multi near layer))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 14:25
-	218	(thermoset\$4) near5 (resin or adhesive) near5 (coat or coated or coating) near5 (copper or conductor)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 14:26
-	16	((thermoset\$4) near5 (resin or adhesive) near5 (coat or coated or coating) near5 (copper or conductor)) same prepreg	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 14:26
-	26	dye near20 resin near20 prepreg	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 15:47
-	9	("2569793"   "3298959"   "3926658"   "4183767"   "4365516"   "4392982"   "4400618"   "4538909"   "4549206").PN.	USPAT	2004/09/23 15:47
-	5	4697923.URPN.	USPAT	2004/09/23 15:47
-	86	dye near20 resin near20 (fluoropolymer or ptfe or (polytetrafluoroethylene))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/09/23 15:49
-	0	6534160.URPN.	USPAT	2004/09/23 15:49
-	2	6254972.URPN.	USPAT	2004/09/23 15:50